

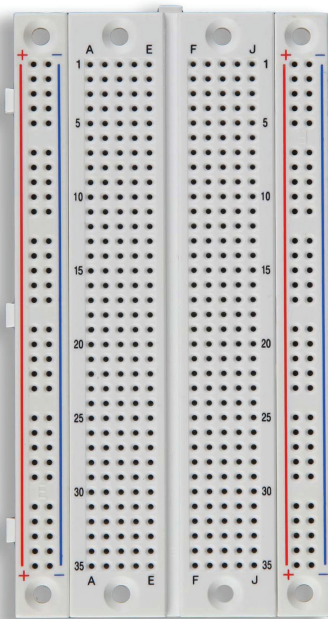
EXP-355

470 TIE-POINT, SOLDERLESS BREADBOARD WITH BUS STRIP

Applications

The GS-470 is a modular type solderless breadboard that is comprised of the GS-060 bus strip and the GS-351 breadboard. It is a great way to prototype low frequency or DC powered circuits. They are ideal for:

- Educational labs
- Hobbyists



Features

- 470 Tie-points
- ABS plastic body
- Round hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 5 total 16-pin ICs
- Measures 4.12 x 2.31 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

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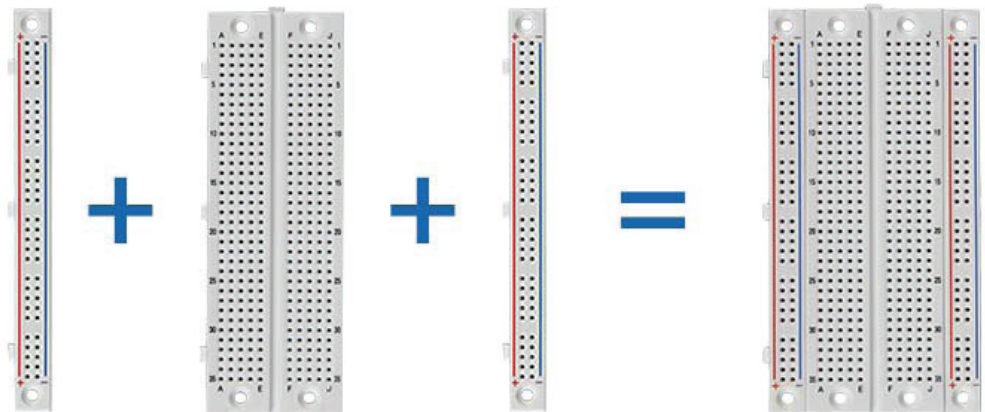
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EXP-355 Components



GS-060*

GS-351

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*The GS-060 is sold as a pack of two